

- High tensile lead free brass -

H75

Material designation	Chemical composition*			
C67500 - ASTM B138	Elements	% mean	Impurities	% max.
	Cu	58.7	Pb	0.1
	Fe	1.2	Ni	0.20
	Sn	0.6		
	Mn	0.3		
	Zn	balance		

* Reference values in % by weight

Properties and typical applications

High strength lead free brass for machining and stamping. Aeronautics, automotive equipment...

Physical properties at 20°C		Heat treatment	
Density (g/cm ³)	8,4	Melting range (°C)	890-910
Young modulus (GPa)	103	Hot working (°C)	650-750
Thermal expansion coefficient (20-300°C) (10 ⁻⁶ /K)	21	Annealing temperature (°C)*	500-600
Thermal conductivity (W/m.K)	105	Stress relieving treatment (°C)**	300-400
Thermal capacity (J/Kg.K)	377	<i>* Annealing treatment of a material leads to reduce its hardness and increase its ductility.</i>	
Electrical conductivity (% I.A.C.S.)	24	<i>** Stress relieving treatment allows to eliminate the residual stresses present in the material in order to avoid the stress corrosion cracking.</i>	

Forming		Joining	
Hot forming	Good	Soldering	
Cold forming	Fair	Soft	Excellent
Machinability	50% (CuZn39Pb3 = 100%)	Hard	Excellent
Corrosion resistance		Welding	
High tensile brasses generally exhibit good corrosion resistance to organic materials and neutral or alkaline compounds due to alloying elements.		Gaz welding	Fair
		Inert gas shielded arc welding	Not recommended
		Resistance welding	Not recommended

Mechanical properties (indicative values)

Yield Strength Rp _{0,5} [Mpa]	> 240
Tensile Strength Rm [Mpa]	> 480
Elongation [%]	> 15
Hardness [HB]	> 120

Fabrication range

Available forms:



Do not hesitate to contact us for further information regarding the dimensions, tolerances and metallurgical conditions. Our technical teams are by your side to help you succeed in your projects.

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